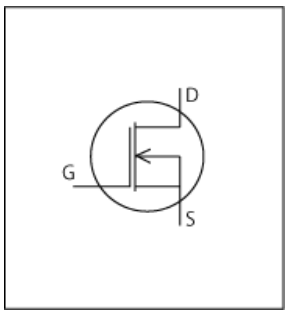
LTspice Model
NMOS
ON
NDUL03N150CG



Model Information

Model	A macro model based on BSIM3 model	
Call Name	MDC_NDUL03N150CG_LT	
Pin Assign	1:G 2:D 3:S	
File List	Model Library	MDC_NDUL03N150CG_LT01.lib
	Model Report	MDC_NDUL03N150CG_LT.pdf (this file)
Verified Simulator Version		LTspice version XVII
Note		

References

The information which was used for modeling is as follow:

[Data Sheet]

- ●Date/Version: September, 2013
- ●Product name: NDUL03N150CG
- ●Company name: ON Semiconductor.
- ●Characteristics: IdVds[Vgs],IdVgs[Temp],Rds(on)Vgs[Temp],Rds(on)Temp[Vgs],YfsId[Temp],IsVsd[Temp],SwitchingIdd[Tname],CapacitanceVds[Cname],VgsQg[Vdd],TrrIf[Ir],QrrIf[Ir],SwitchingWaveform,TrrWaveform

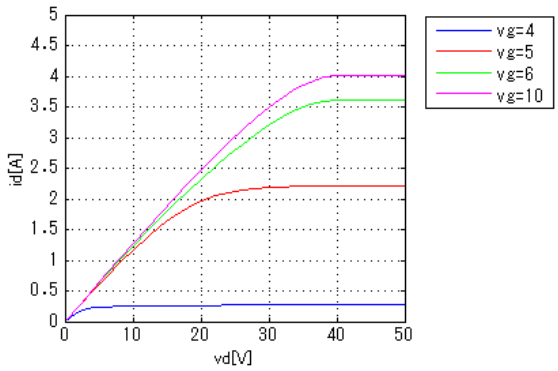
Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

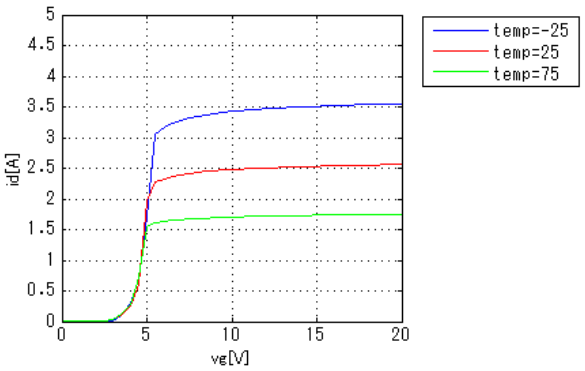
Item	Range			Unit
	Min.		Max.	
Drain-source voltage (DC)	0	to	1,500	V
Gate-source voltage (DC)	-30	to	30	V
Temperature	-55	to	150	deg C

Simulation results are following.
Explanatory notes — : simulated

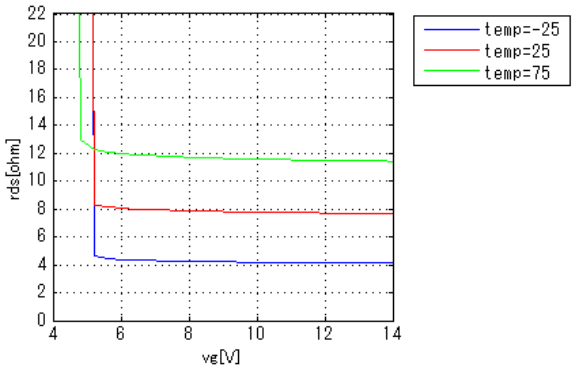
IdVds[Vgs]
Temp. = 25degC



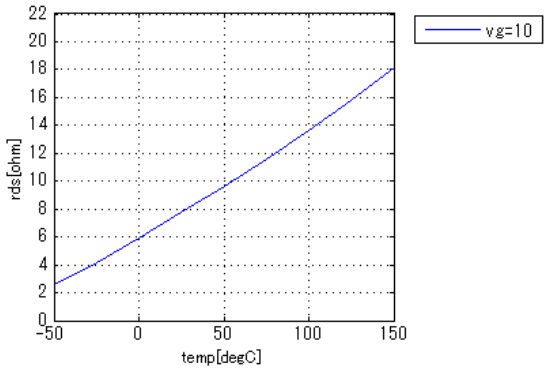
IdVgs[Temp]
Vds = 20V



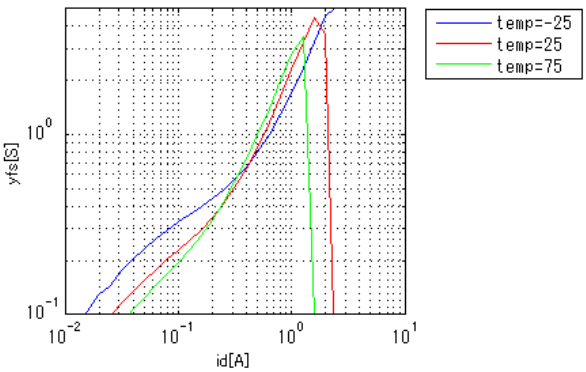
Rds(on)Vgs[Temp]
Id = 1.25A



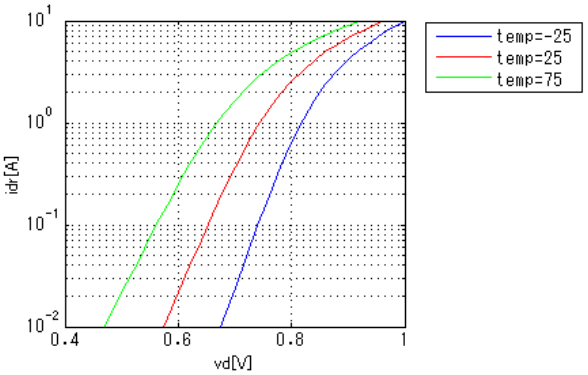
Rds(on)Temp[Vgs]
Id = 1.25A



YfsId[Temp]
Vds = 20V



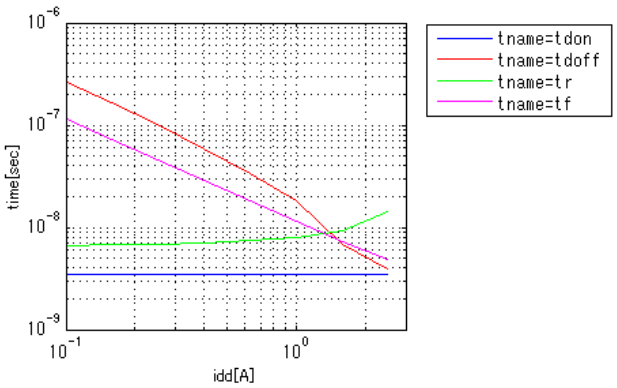
IsVsd[Temp]
vg = 0V



Simulation results are following.
Explanatory notes — : simulated

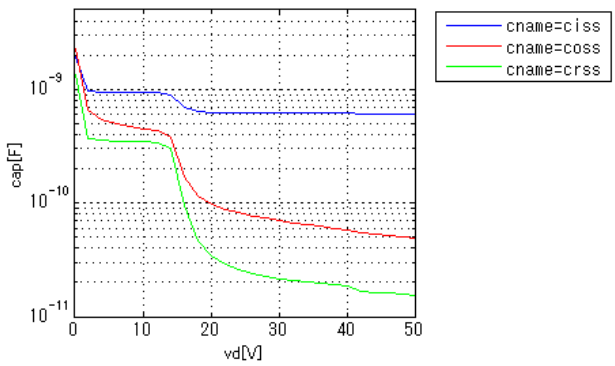
SwitchingIdd[Tname]

vgg = 10V, vdd = 200V, RGS = 50ohm



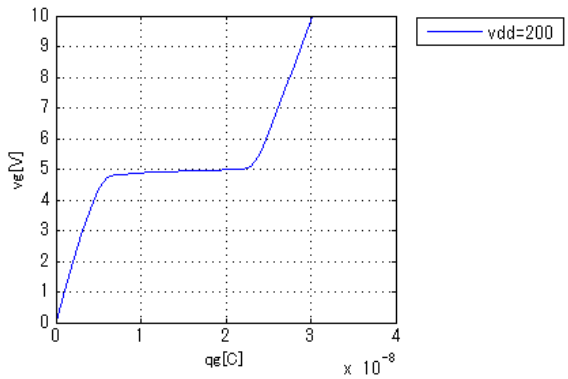
CapacitanceVds[Cname]

freq = 1000000Hz



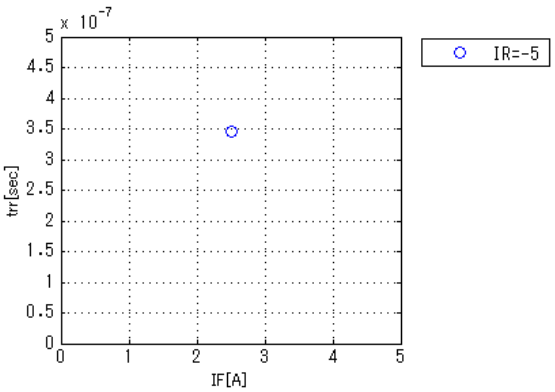
VgsQg[Vdd]

Id = 2.5A



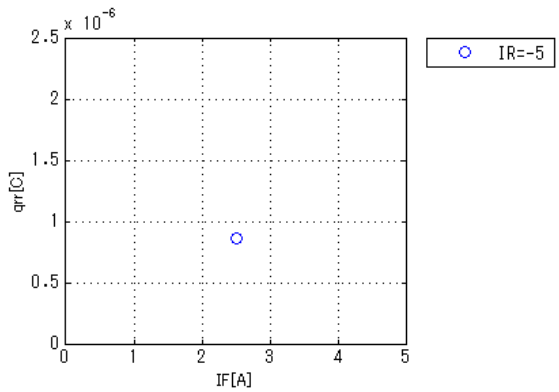
TrrIf[Ir]

vdd = 60V, didt = 100A/us, Temp = 25degC



QrrIf[Ir]

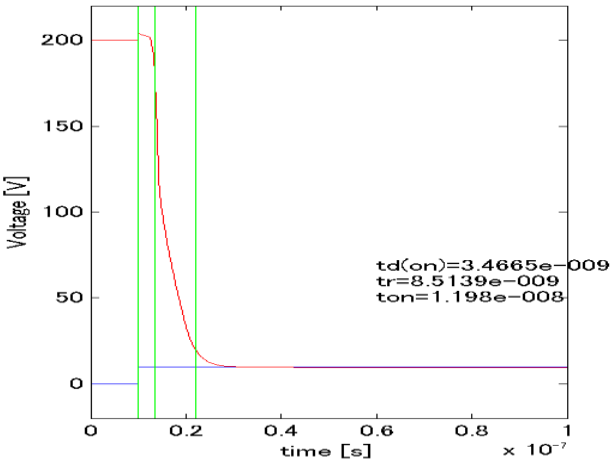
vdd = 60V, didt = 100A/us, Temp = 25degC

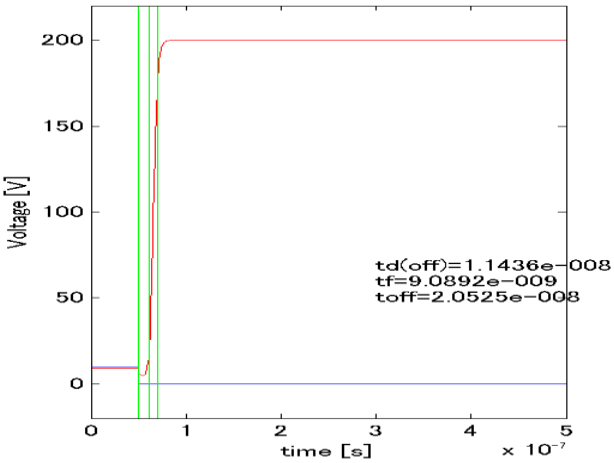


Simulation results are following.
Explanatory notes — : simulated

Switching Waveform (Blue : INPUT Red : OUTPUT)

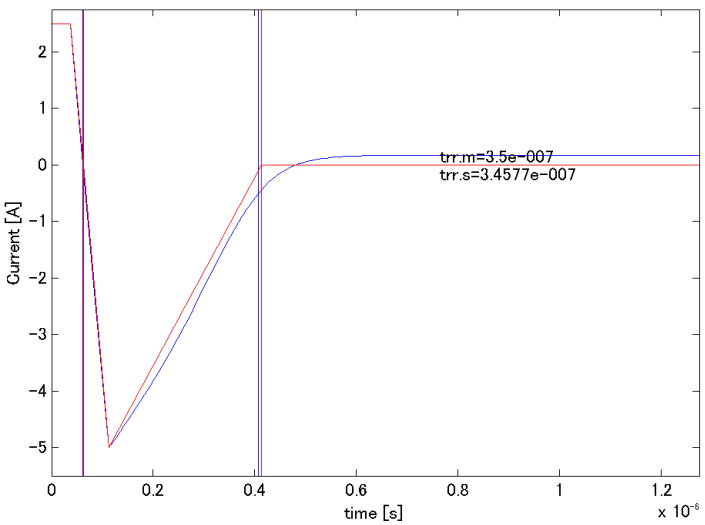
vgg = 10V, vdd = 200V, RGS = 50ohm, idd = 1.25A





Trr Waveform (Red : Datasheet Blue : Simulation)

vdd = 60V, didt = 100A/us, Temp = 25degC



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